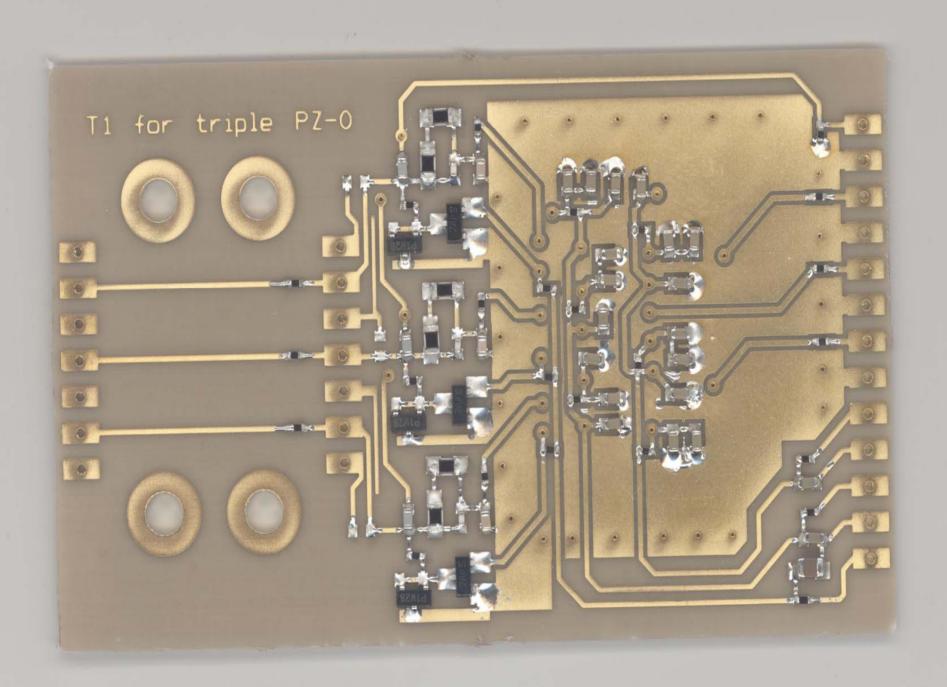
Status of FE circuit radioactivity measurements

Dr. Matthias Laubenstein Laboratori Nazionali del Gran Sasso ITALY

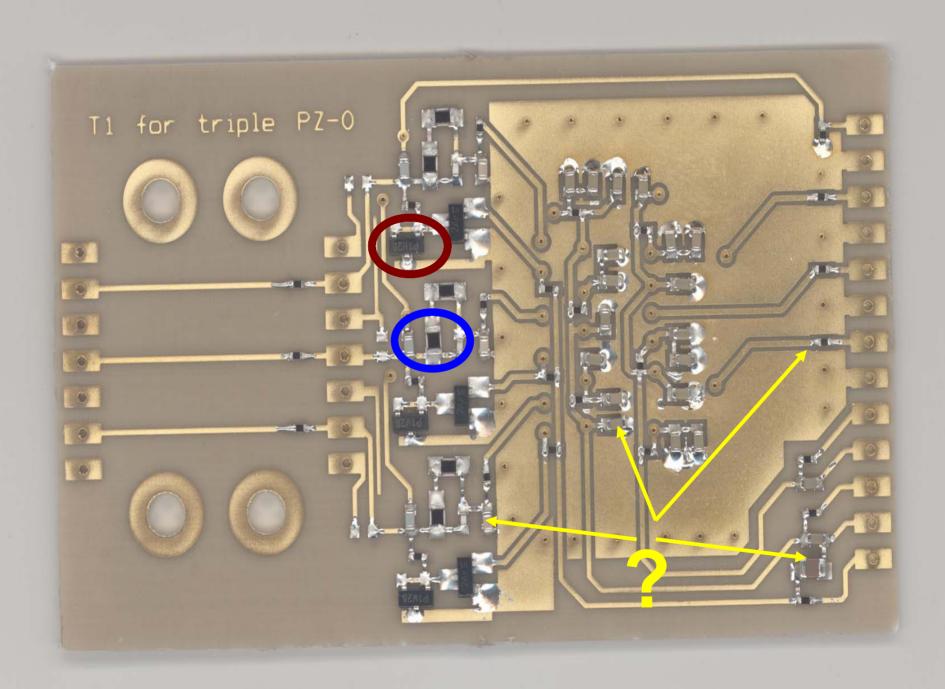
> GERDA General Meeting Padova (Italy) March 11 - 13, 2009

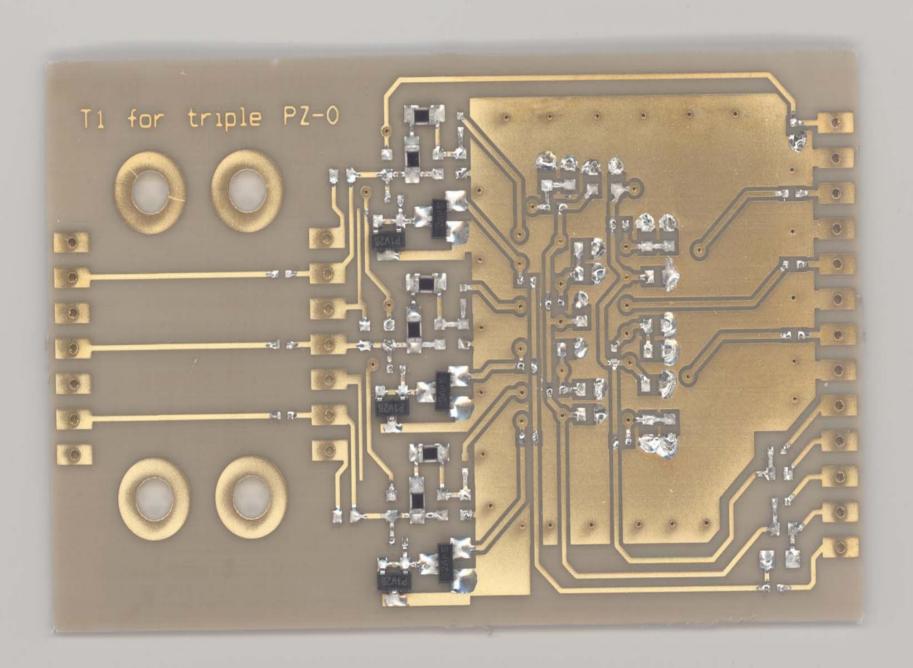


Radionuclide concentrations per PCB

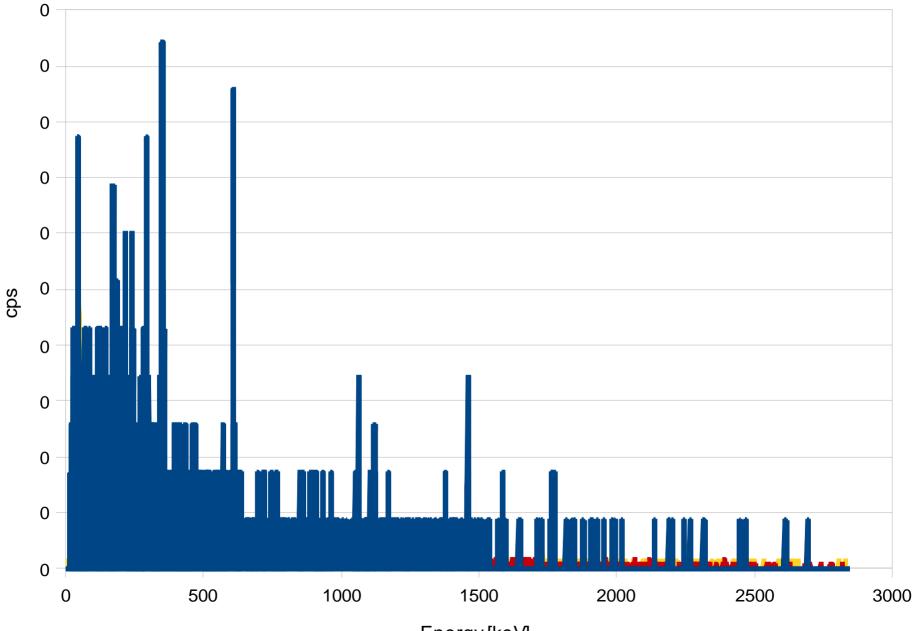
item	mass	²²⁶ Ra	²²⁸ Ra	²²⁸ Th	⁴⁰ K
PCB	6.5 g	6.3 ± 0.5	0.21 ± 0.13	0.19 ± 0.08	2.2 ± 0.7
Cuflon	4.4 g	< 3.5 E-3	< 12 E-3	< 7.9 E-3	0.19 ± 0.06
solder	~2 g	< 9.6 E-3	< 9.2 E-3	< 13 E-3	< 0.10
FET	0.05 g	31 ± 8 E-3	s < 26 E-3	33 ± 8 E-3	< 0.12
Big res.	0.03 g	< 22 E-3	< 20 E-3	< 20 E-3	< 0.21

unit in mBq



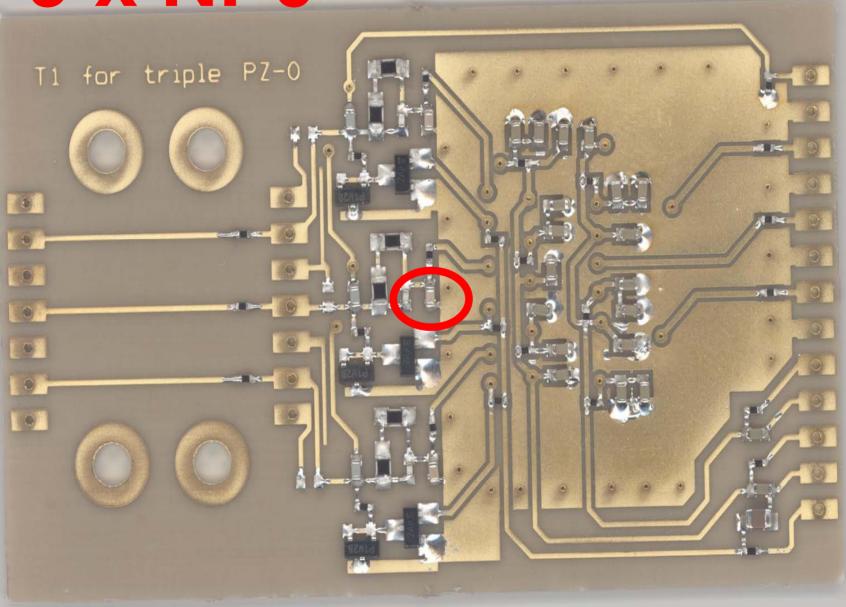


PCB 1 - with and without components & bg

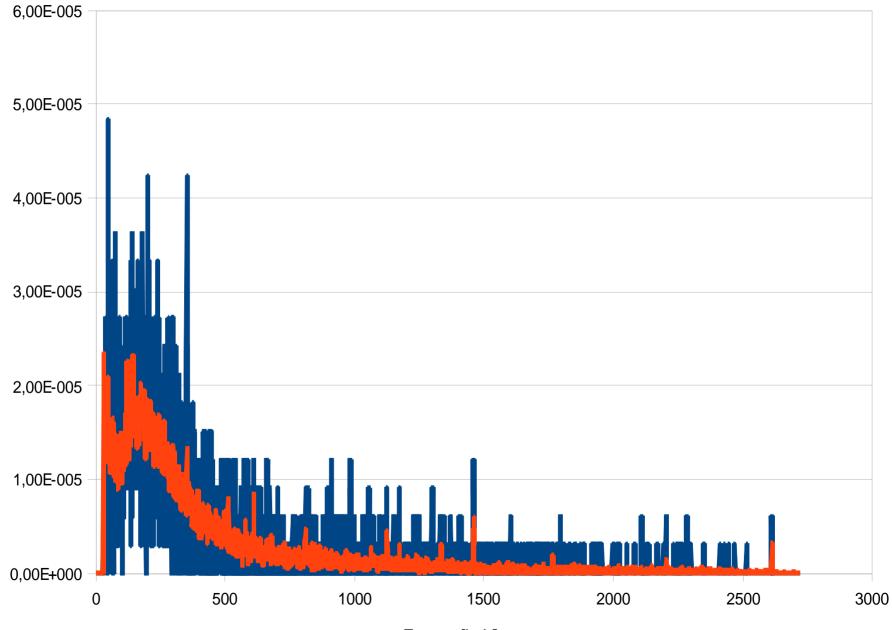


Energy [keV]





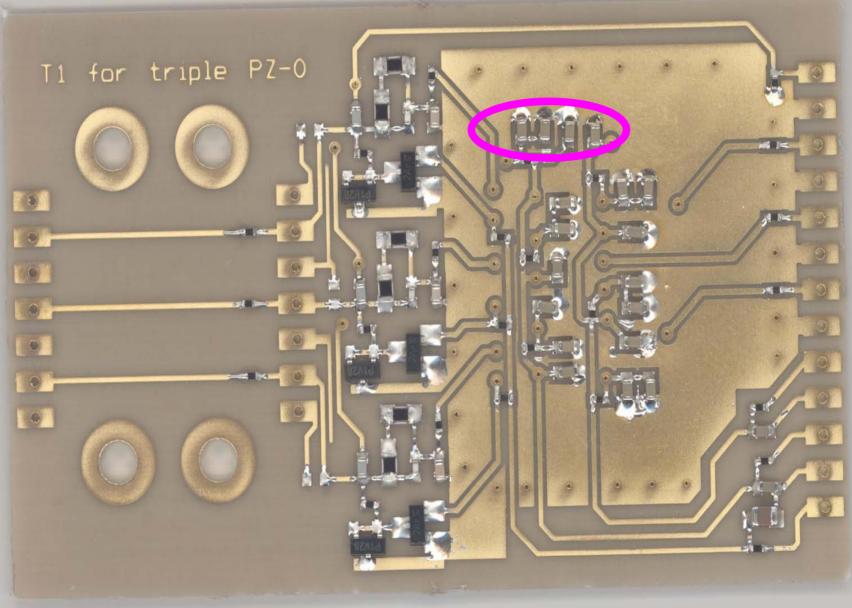
capacitors NP0 & bg



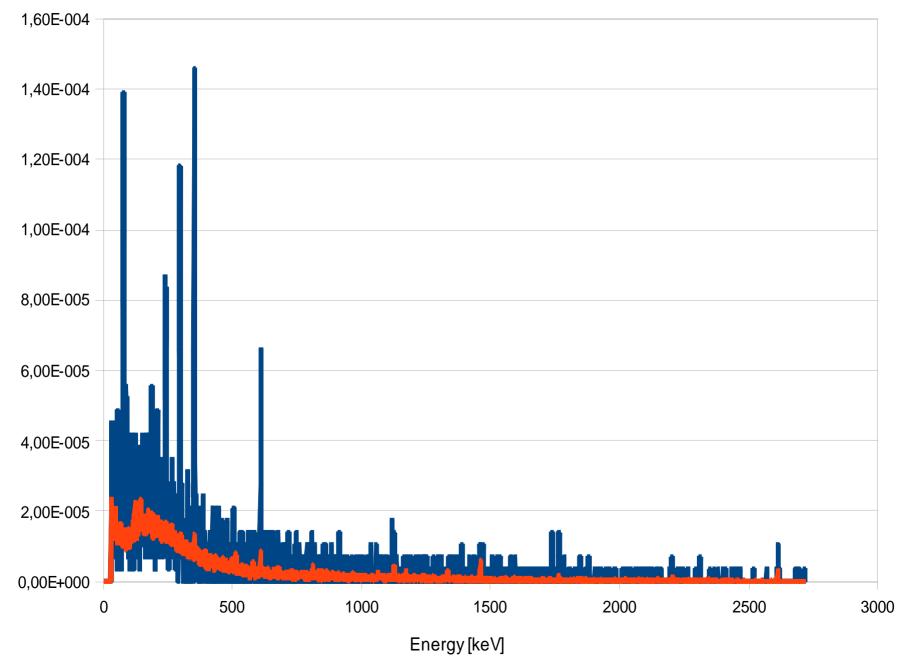
cps

Energy [keV]





capacitors X5R & bg



cbs





24 x small res



Ongoing measurements

- in 14 days from now one should have identified ALL components that contribute to the overall activity.
- good news: we do not have to substitute neither the substrate, nor the FET nor the big resistors;
- solder is a problem only for the ²¹⁰Pb (~ 200 Bq/kg), if any ...
- we have to look out NOW for substitutes for the capacitors, which in fact have never been screened before;

LESSON TO BE LEARNED

 EVERYTHING which goes into the detector or close to it MUST be screened BEFORE in order to avoid bad surprises.

- It is not enough to look out for old measurements thinking that the new material will be the same or at least similar.